

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT																
NATURE OF CONVEYANCE:	ASSIGNMENT																
CONVEYING PARTY DATA																	
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CORRESPONDENCE DATA																	
Fax Number: (202)739-3001 Email: patents@morganlewis.com, kcasavecchia@morganlewis.com <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i> Correspondent Name: Robert J. Gaybrick Address Line 1: 1111 Pennsylvania Ave, NW Address Line 4: Washington, DISTRICT OF COLUMBIA 20004																	
ATTORNEY DOCKET NUMBER:	001082-7071																

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PATENT
REEL: 027305 FRAME: 0405

NAME OF SUBMITTER:

Robert J. Goodell

Total Attachments: 2

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ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

AIR CONDITIONER

for which I/WE executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on _____, (Application No. _____); and

WHEREAS, LG ELECTRONICS INC., a corporation of Republic of Korea, whose post office address is 20 Yeouido-dong Yeongdeungpo-gu Seoul 150-721 Republic of Korea, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parenthesis (Application No. 29/407,521, filed Nov. 30, 2011) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).

Full Name of Sole or First Assignor Taehi KIM	Assignor's Signature <i>Taehi Kim</i>	Date November 23, 2011
Address Samik Green Apt. 501-1502, Myeongil-dong 15, Gangdong-gu, Seoul, Korea		Citizenship Republic of Korea
Full Name of Second Assignor Seungho BAEK	Assignor's Signature <i>Seungho Baek</i>	Date November 23, 2011
Address Daesim Apt. 102-603, Dogok-dong, Gangnam-gu, Seoul, Korea		Citizenship Republic of Korea
Names of additional inventors attached ☒ Yes ☐ No		

Full Name of Third Assignor Gangui CHO	Assignor's Signature <i>Gangui Cho</i>	Date November 23, 2011
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Full Name of Fourth Assignor Sehwan BAE	Assignor's Signature <i>Sehwan Bae</i>	Date November 23, 2011
Address Moraksan Hyundai Apt. 101-1604, Ojeon-dong, Uhwang-si, Gyeonggi-do, Korea		Citizenship Republic of Korea
Full Name of Fifth Assignor Joogyean KIM	Assignor's Signature <i>Joogyean Kim</i>	Date November 23, 2011
Address Dongbu Haeoreum Apt. 101-901, Yeoksam-dong 716, Gangnam-ku, Seoul, Korea		Citizenship Republic of Korea
Full Name of Sixth Assignor Hyein JUNG	Assignor's Signature <i>Hyein Jung</i>	Date November 23, 2011
Address Raemian Firstige Apt. 112-1401, Banpo-2-dong 18-1, Seocho-gu, Seoul, Korea		Citizenship Republic of Korea
Full Name of Seventh Assignor Jaewon JEONG	Assignor's Signature <i>Jaewon Jeong</i>	Date November 23, 2011
Address 230-91, Gugi-dong, Jongno-gu, Seoul, Korea		Citizenship Republic of Korea
Full Name of Eighth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Ninth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Tenth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Eleventh Assignor	Assignor's Signature	Date
Address		Citizenship
Names of additional inventors attached ☐ Yes ☒ No		